



# LMV321-LMV358-LMV324

## Low Cost, Low Power Input/Output Rail-to-Rail Operational Amplifiers

- Operating at  $V_{CC} = 2.7V$  to  $6V$
- Rail-to-rail input & output
- Extended  $V_{icm}$  ( $V_{DD} - 0.2V$  to  $V_{CC} + 0.2V$ )
- Low supply current ( $145\mu A$ )
- Gain bandwidth product ( $1MHz$ )
- ESD tolerance ( $2kV$ )
- Latch-up immunity
- Available in SOT23-5 micropackage

### Description

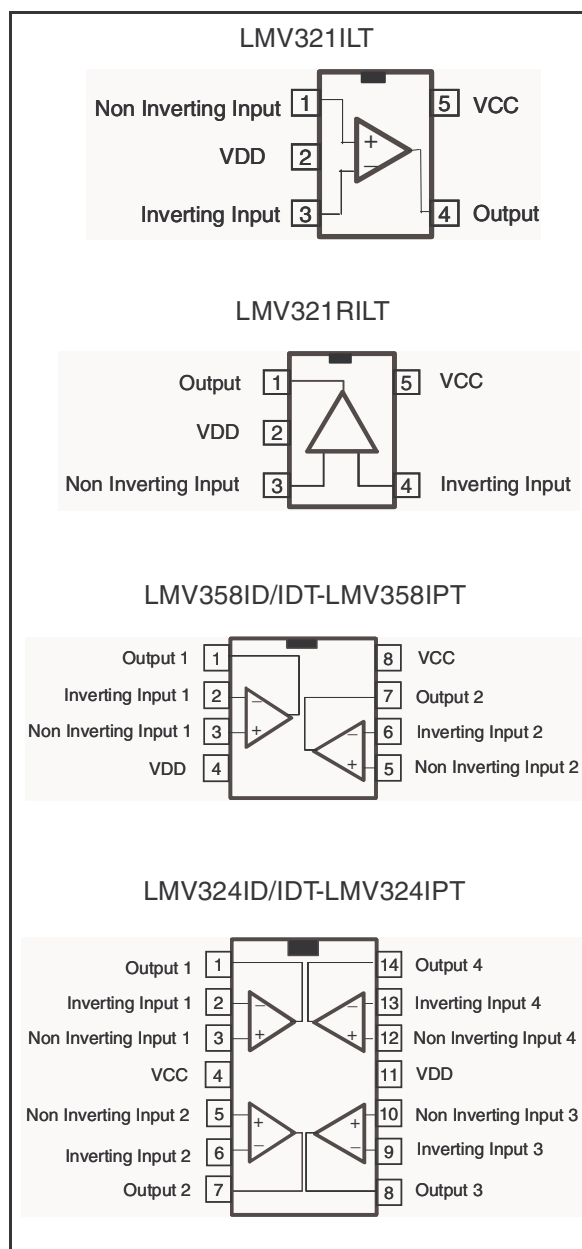
The LMV321/358/324 (single, dual & quad) family answer the need for low cost, general purpose operational amplifiers. It operates with voltages as low as  $2.7V$  and features both input and output rail-to-rail,  $145\mu A$  consumption current and  $1MHz$  Gain Bandwidth Product (GBP).

With a such low consumption and a sufficient GBP for many applications, this op-amp is very well-suited for any kind of battery-supplied and portable equipment applications.

The LMV321 is housed in the space-saving 5 pin SOT23-5 package which simplifies the board design (outside dimensions are  $2.8mm \times 2.9mm$ ). The SOT23-5 has two pinning configurations to answer all applications needs.

### Applications

- Two-cell battery-powered systems
- Battery-powered electronic equipment
- Cordless phones
- Personal medical care (glucose meter)
- Laptops
- PDAs



1      **Order Codes**

Part Number	Temperature Range	Package	Packaging	Marking
LMV321ILT	-40°C, +125 °C	SOT23-5	Tape & Reel	K177
LMV321RILT				K176
LMV358ID/IDT		SO-8	Tube or Tape & Reel	LMV358
LMV358IPT		TSSOP8 (Thin Shrink Outline Package)	Tape & Reel	MV358
LMV324ID/IDT		SO-14	Tube or Tape & Reel	LMV324
LMV324IPT		TSSOP14 (Thin Shrink Outline Package)	Tape & Reel	MV324



## 2 Absolute Maximum Ratings

**Table 1. Key parameters and their absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage <sup>(1)</sup>	7	V
$V_{id}$	Differential Input Voltage <sup>(2)</sup>	$\pm 1$	V
$V_i$	Input Voltage	$V_{dd}-0.3$ to $V_{cc}+0.3$	V
$T_{oper}$	Operating Free Air Temperature Range	-40 to + 125	°C
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_j$	Maximum Junction Temperature	150	°C
$R_{thja}$	Thermal Resistance Junction to Ambient <sup>(3)</sup>		
	SOT23-5	250	°C/W
	SO-8	125	
	SO-14	103	
	TSSOP8	120	
	TSSOP14	100	
$R_{thjc}$	Thermal Resistance Junction to Case		
	SOT23-5	81	°C/W
	SO-8	40	
	SO-14	31	
	TSSOP8	37	
	TSSOP14	32	
ESD	HBM: Human Body Model <sup>(4)</sup>	2	kV
	MM: Machine Model <sup>(5)</sup>	200	V
	CDM: Charged Device Model <sup>(6)</sup>	1.5	kV
	Lead Temperature (soldering, 10sec)	250	°C
	Output Short Circuit Duration	see note <sup>(7)</sup>	

1. All voltages values, except differential voltage are with respect to network terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal. If  $V_{id} > \pm 1V$ , the maximum input current must not exceed  $\pm 1mA$ . In this case ( $V_{id} > \pm 1V$ ) an input serie resistor must be added to limit input current.
3. Short-circuits can cause excessive heating. Destructive dissipation can result from simultaneous short-circuit on all amplifiers. All values are typical.
4. Human body model, 100pF discharged through a 1.5k $\Omega$  resistor into pin of device.
5. Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor < 5 $\Omega$ ), into pin to pin of device.
6. No value specified for CDM on SOT23-5L package. Value is given for SO and TSSOP packages.
7. Short-circuits from the output to  $V_{CC}$  can cause excessive heating. The maximum output current is approximately 48mA, independent of the magnitude of  $V_{CC}$ . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	2.7 to 6	V
$V_{icm}$	Common Mode Input Voltage Range <sup>(1)</sup>	$V_{dd} - 0.2$ to $V_{CC} + 0.2$	V
$V_{icm}$	Common Mode Input Voltage Range <sup>(2)</sup>	$V_{dd}$ to $V_{CC}$	V
$T_{oper}$	Operating Free Air Temperature Range	-40 to + 125	°C

1. At 25°C, for  $2.7 \leq V_{CC} \leq 6V$ ,  $V_{icm}$  is extended to  $V_{dd} - 0.2V$ ,  $V_{CC} + 0.2V$ .
2. In full temperature range, both Rails can be reached when  $V_{CC}$  does not exceed 5.5V.

### 3 Electrical Characteristics

**Table 3.**  $V_{CC} = +2.7V$ ,  $V_{DD} = 0V$ ,  $C_L$  &  $R_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		0.1	3 6	mV
$\Delta V_{io}$	Input Offset Voltage Drift			2		$\mu V/^\circ C$
$I_{io}$	Input Offset Current	$V_{icm} = V_{out} = V_{CC}/2$ <sup>(1)</sup> $T_{min} \leq T_{amb} \leq T_{max}$		1	9 25	nA
$I_{ib}$	Input Bias Current	$V_{icm} = V_{out} = V_{CC}/2$ <sup>(1)</sup> $T_{min} \leq T_{amb} \leq T_{max}$		10	50 85	nA
CMR	Common Mode Rejection Ratio	$0 \leq V_{icm} \leq V_{CC}$	55	85		dB
SVR	Supply Voltage Rejection Ratio	$V_{icm} = V_{CC}/2$	70	80		dB
$A_{vd}$	Large Signal Voltage Gain	<b><math>V_{out} = 0.5V</math> to <math>2.2V</math></b> $R_L = 10k\Omega$ $R_L = 2k\Omega$	80 70	100 88		dB
$V_{OH}$	High Level Output Voltage	<b><math>V_{id} = 100mV</math></b> <b><math>T_{min} \leq T_{amb} \leq T_{max}</math></b> $R_L = 10k\Omega$ $R_L = 2k\Omega$	2.6 2.55	2.65 2.6		V
$V_{OL}$	Low Level Output Voltage	<b><math>V_{id} = -100mV</math></b> <b><math>T_{min} \leq T_{amb} \leq T_{max}</math></b> $R_L = 10k\Omega$ $R_L = 2k\Omega$		15 50	90 100	mV
$I_o$	Output Current	<b>Output Source Current</b> $V_{ID} = 100mV$ , $V_O = V_{DD}$ <b>Output Sink Current</b> $V_{ID} = -100mV$ , $V_O = V_{CC}$	5 5	46 46		mA
$I_{CC}$	Supply Current (per amplifier)	<b><math>V_{out} = V_{CC}/2</math></b> $A_{VCL} = 1$ , no load $T_{min} \leq T_{amb} \leq T_{max}$		145	200 230	$\mu A$
GBP	Gain Bandwidth Product	$R_L = 600\Omega$ , $C_L = 100pF$ , $f = 100kHz$		1		MHz
SR	Slew Rate	$R_L = 600\Omega$ , $C_L = 100pF$ , $A_V = 1$		0.35		V/ $\mu s$
$\phi_m$	Phase Margin	$R_L = 600\Omega$ , $C_L = 100pF$		44		Degrees
en	Input Voltage Noise			40		nV/ $\sqrt{Hz}$
THD	Total Harmonic Distortion			0.01		%

1. Maximum values including unavoidable inaccuracies of the industrial test.

Table 4.  $V_{CC} = +5V$ ,  $V_{dd} = 0V$ ,  $C_L$  &  $R_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		0.1	3 6	mV
$\Delta V_{io}$	Input Offset Voltage Drift			2		$\mu V/^\circ C$
$I_{io}$	Input Offset Current	$V_{icm} = V_{out} = V_{CC}/2$ <sup>(1)</sup> $T_{min} \leq T_{amb} \leq T_{max}$		1	9 25	nA
$I_{ib}$	Input Bias Current	$V_{icm} = V_{out} = V_{CC}/2$ <sup>(1)</sup> $T_{min} \leq T_{amb} \leq T_{max}$		16	63 95	nA
CMR	Common Mode Rejection Ratio	$0 \leq V_{icm} \leq V_{CC}$	65	95		dB
SVR	Supply Voltage Rejection Ratio	$V_{icm} = V_{CC}/2$	70	90		dB
$A_{vd}$	Large Signal Voltage Gain	<b><math>V_{out} = 0.5V</math> to <math>4.5V</math></b> $R_L = 10k\Omega$ $R_L = 2k\Omega$	85 77	97 93		dB
$V_{OH}$	High Level Output Voltage	<b><math>V_{id} = 100mV</math></b> $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$	4.85 4.8	4.95 4.91		V
$V_{OL}$	Low Level Output Voltage	<b><math>V_{id} = -100mV</math></b> $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10k\Omega$ $R_L = 2k\Omega$		40 80	180 200	mV
$I_o$	Output Current	Output Source Current $V_{ID} = 100mV$ , $V_O = V_{DD}$ Output Sink Current $V_{ID} = -100mV$ , $V_O = V_{CC}$	7 7	48 48		mA
$I_{CC}$	Supply Current (per amplifier)	<b><math>V_{out} = V_{CC}/2</math></b> $A_{VCL} = 1$ , no load $T_{min} \leq T_{amb} \leq T_{max}$		162	220 250	$\mu A$
GBP	Gain Bandwidth Product	$R_L = 600\Omega$ , $C_L = 100pF$ , $f = 100kHz$		1.3		MHz
SR	Slew Rate	$R_L = 600\Omega$ , $C_L = 100pF$ , $A_V = 1$		0.45		V/ $\mu s$
$\phi_m$	Phase Margin	$R_L = 600\Omega$ , $C_L = 100pF$		48		Degrees
en	Input Voltage Noise			40		nV/ $\sqrt{Hz}$
THD	Total Harmonic Distortion			0.01		%

1. Maximum values including unavoidable inaccuracies of the industrial test.

Figure 1. Supply current/amplifier vs. supply voltage

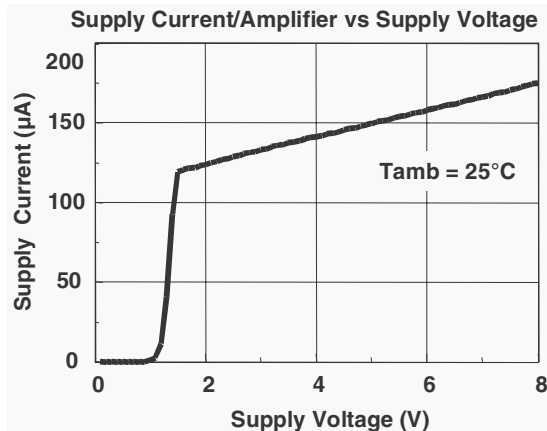


Figure 2. Input bias current vs. temp.

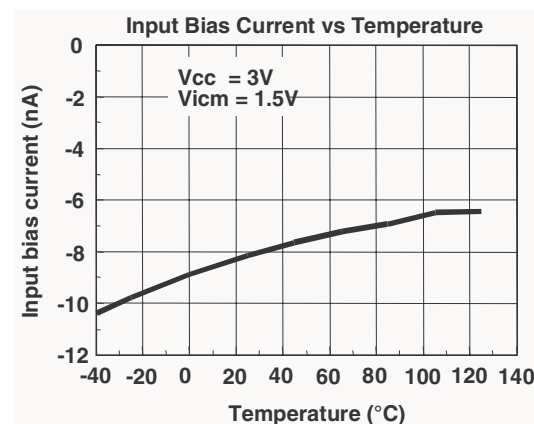


Figure 3. Input bias current vs. temp.

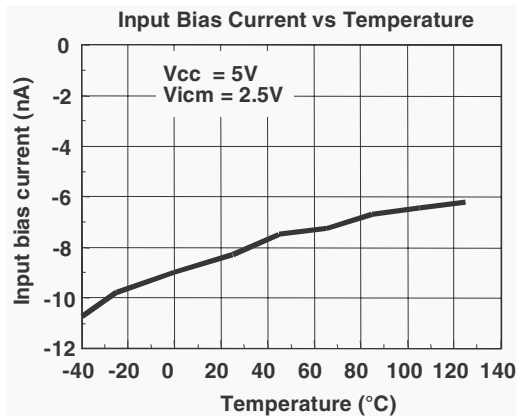


Figure 4. Common mode rejection vs. temp.

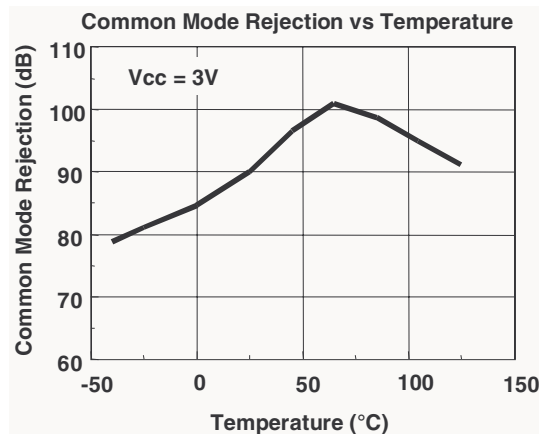


Figure 5. Common mode rejection vs. temp.

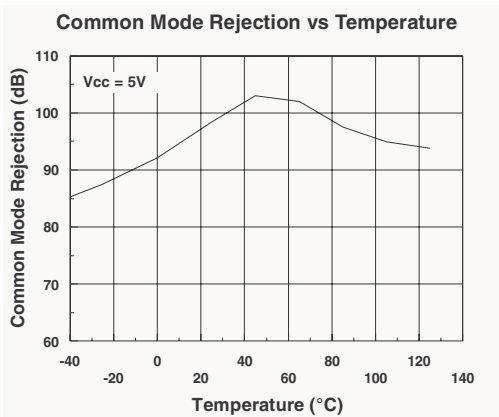


Figure 6. Supply voltage rejection vs. temp.

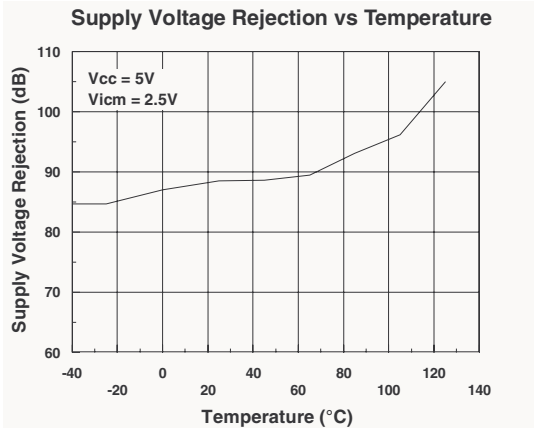


Figure 7. Open loop gain vs. temp.

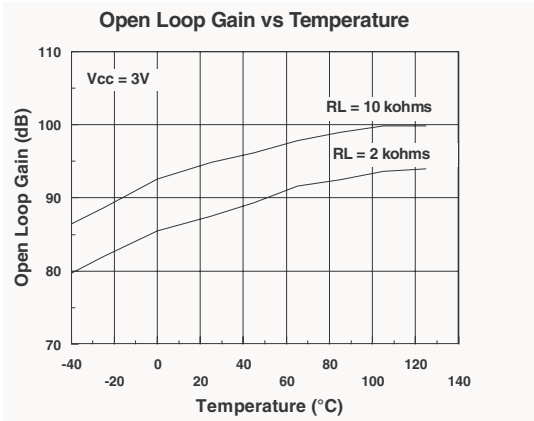


Figure 8. Open loop gain vs. temp.

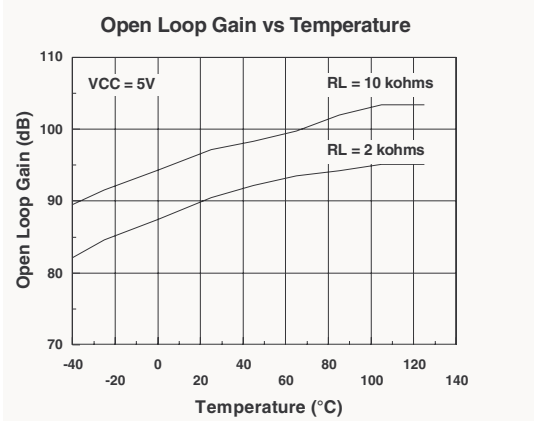


Figure 9. Supply voltage rejection vs. temp.

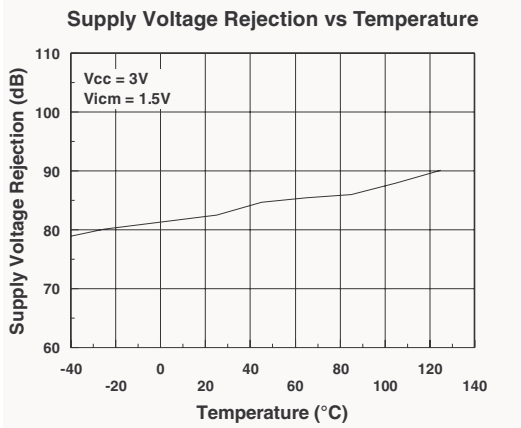


Figure 10. Output current vs. output voltage

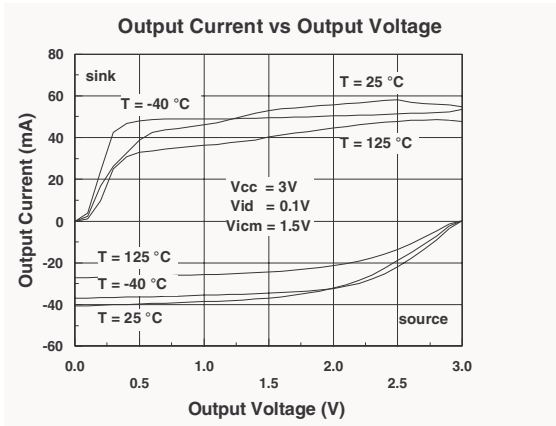
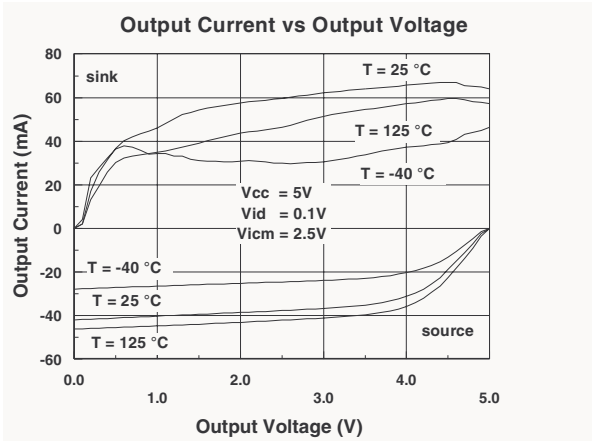


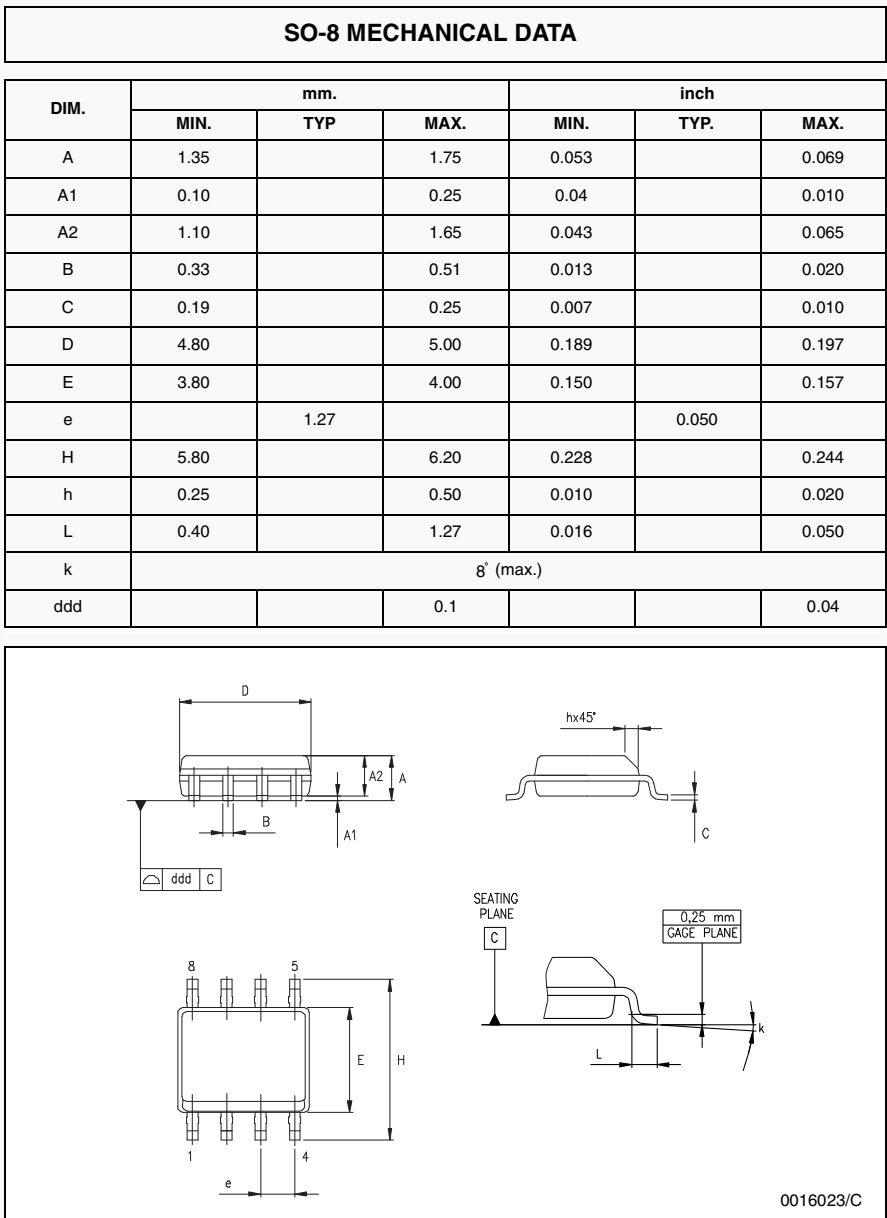
Figure 11. Output current vs. output voltage



4 Package Mechanical Data

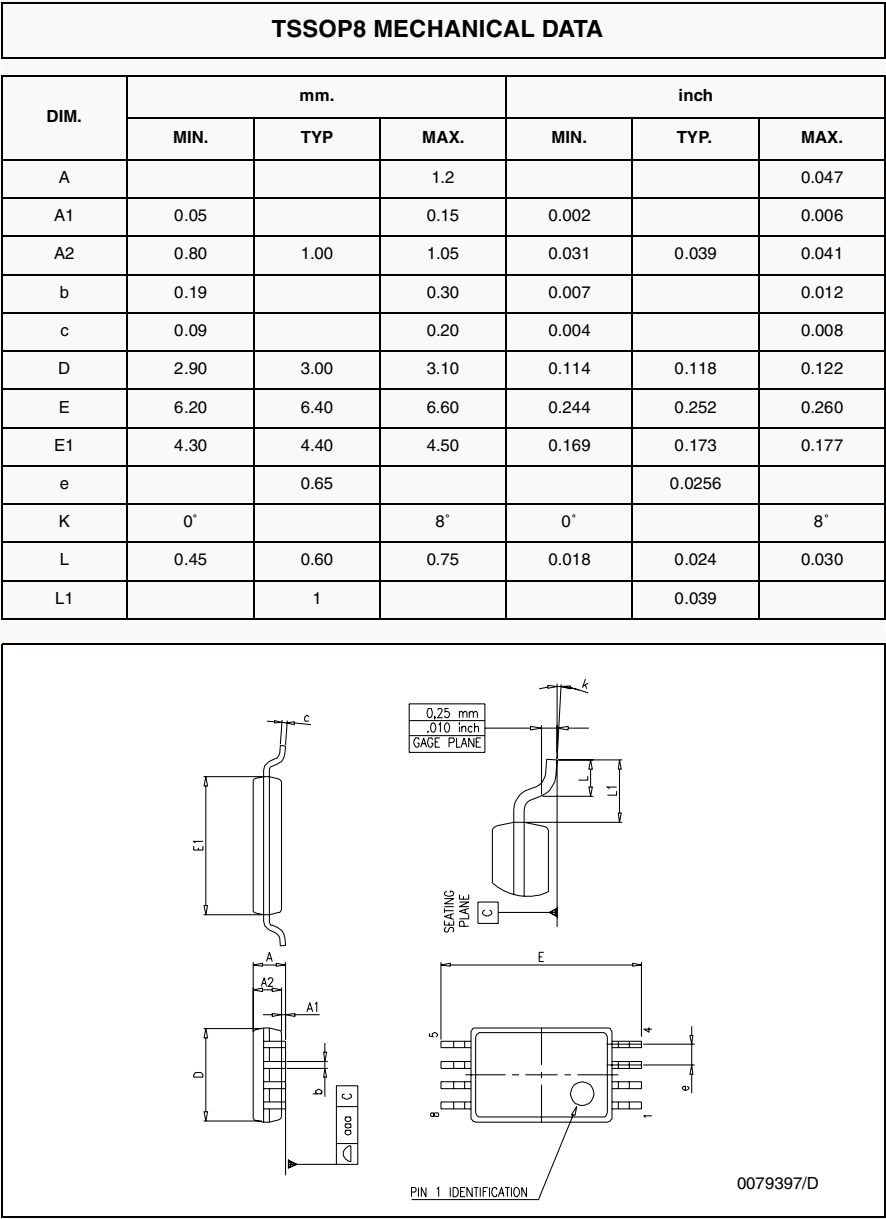
In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

4.1 SO-8 Package

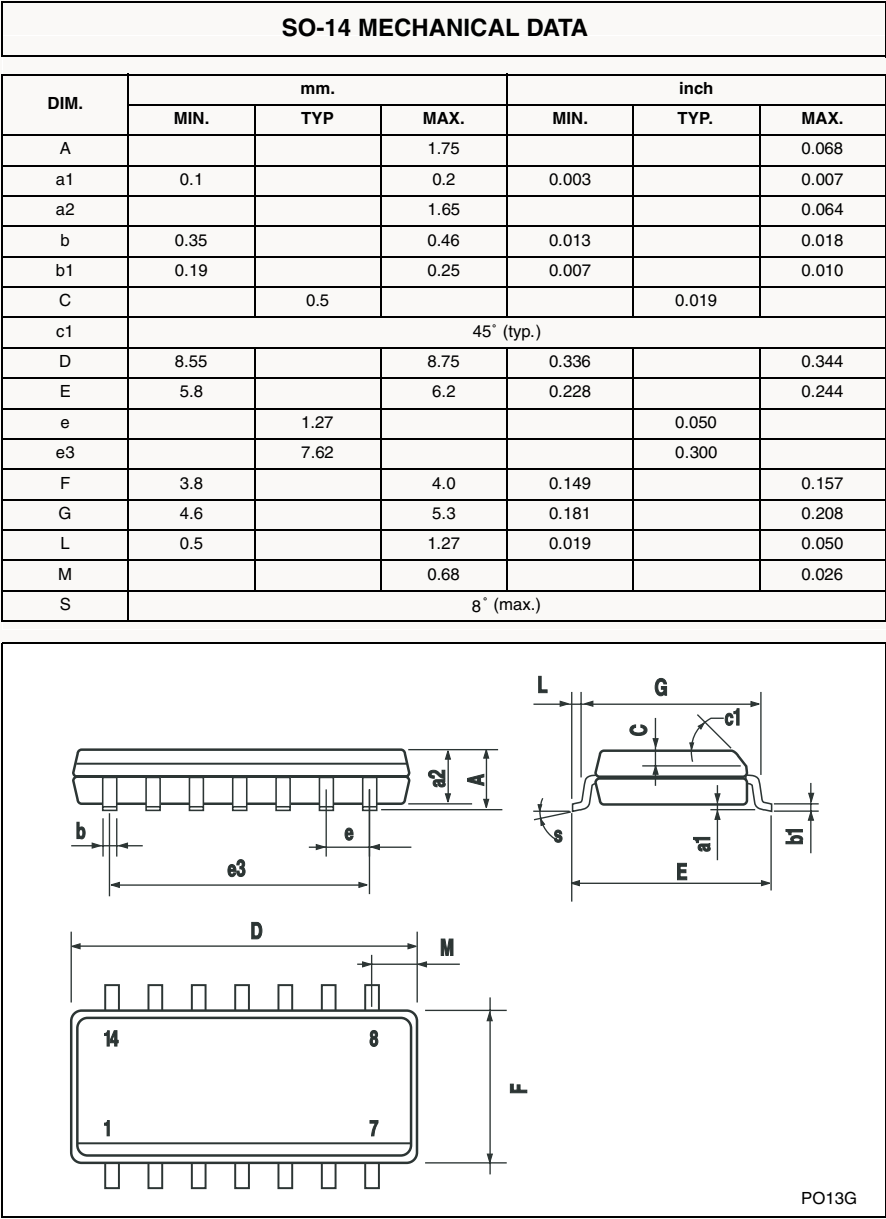




4.2 TSSOP8 Package



4.3 SO-14 Package



### 4.4 TSSOP14 Package

TSSOP14 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030

The mechanical drawing illustrates the TSSOP14 package in three views: a side view at the top showing dimensions A, A1, A2, b, c, and e; a top view at the bottom showing dimensions D, E, and E1, with a circle indicating the pin 1 location; and a side view on the right showing dimensions K and L. The pin 1 identification is marked with a circle and the number 1.

0080337D

4.5 SOT23-5 Package

SOT23-5L MECHANICAL DATA						
DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.0		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6

The diagram illustrates the mechanical dimensions of the SOT23-5L package. The left view is a side profile showing dimensions A (total width), A1 (lead thickness), A2 (lead length), b (lead thickness at base), C (lead width), and L (lead height). The right view is a top-down perspective showing dimensions D (package width), E (package height), E1 (package height excluding leads), e (pitch between leads), e1 (total lead pitch), and b (lead thickness at base).

# 5      Revision History

Table 5.      Document revision history

Date	Revision	Changes
Dec. 2005	1	First Release - Products in full production.

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